# LNJ727W83RAS

Surface Mounting Chip LED

USS-3 Type

### Absolute Maximum Ratings $T_a = 25^{\circ}C$

#### • Pure Green

Parameter	Symbol	Rating	Unit	
Power dissipation	P <sub>D</sub>	65	mW	
Forward current	I <sub>F</sub>	15	mA	
Pulse forward current *	I <sub>FP</sub>	50	mA	
Reverse direct current	I <sub>RDC</sub>	100	mA	
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C	
Storage temperature	T <sub>stg</sub>	-40 to +100	°C	

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

#### • Orange

Parameter	Symbol	Rating	Unit
Power dissipation	P <sub>D</sub>	70	mW
Forward current	I <sub>F</sub>	20	mA
Pulse forward current *	I <sub>FP</sub>	60	mA
Reverse voltage	V <sub>R</sub>	4	V
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C
Storage temperature	T <sub>stg</sub>	-40 to +100	°C

Note) \*: The condition of IFP is duty 10%, Pulse width 1 msec.

#### • Blue

Parameter	Symbol	Rating	Unit
Power dissipation	P <sub>D</sub>	65	mW
Forward current	I <sub>F</sub>	15	mA
Pulse forward current *	I <sub>FP</sub>	50	mA
Reverse direct current	I <sub>RDC</sub>	100	mA
Operating ambient temperature	T <sub>opr</sub>	-30 to +85	°C
Storage temperature	T <sub>stg</sub>	-40 to +100	°C

Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

### Electro-Optical Characteristics $T_a = 25^{\circ}C$

#### • Pure Green

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I <sub>O</sub>	$I_F = 5 \text{ mA}$	30	60	120	mcd
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		3.1	3.8	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 5 \text{ mA}$		525		nm
Dominant emission wavelength *2	λ <sub>d</sub>	$I_F = 5 \text{ mA}$				
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		45		nm

Note) \*1: Measurement tolerance: ±15%

\*2: Measurement tolerance: ±3 nm

### Lighting Color

- Pure Green
- Orange
- Blue

## LNJ727W83RAS

# **Panasonic**

### Electro-Optical Characteristics (Continued) $T_a = 25^{\circ}C$

• Orange

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	Io	$I_F = 10 \text{ mA}$	20	45	80	mcd
Reverse current	I <sub>R</sub>	$V_R = 4 V$			100	μΑ
Forward voltage	V <sub>F</sub>	$I_F = 10 \text{ mA}$		2.0	2.5	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 10 \text{ mA}$		630		nm
Dominant emission wavelength *2	$\lambda_d$	$I_F = 10 \text{ mA}$	610	620	630	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$		15		nm

Note) \*1: Measurement tolerance:  $\pm 15\%$ 

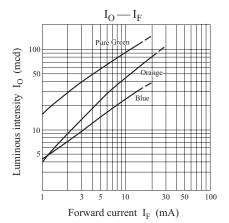
\*2: Measurement tolerance: ±3 nm

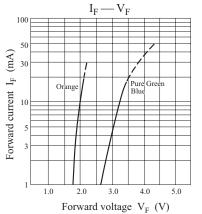
#### • Blue

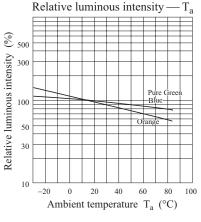
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I <sub>O</sub>	$I_F = 5 \text{ mA}$	5	15	35	mcd
Forward voltage	V <sub>F</sub>	$I_F = 5 \text{ mA}$		3.1	3.8	V
Peak emission wavelength	$\lambda_{P}$	$I_F = 5 \text{ mA}$		470		nm
Dominant emission wavelength *2	λ <sub>d</sub>	$I_F = 5 \text{ mA}$	465	472	480	nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$		30		nm

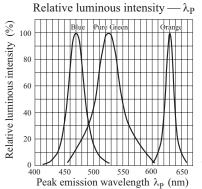
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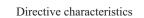
\*2: Measurement tolerance:  $\pm 3 \text{ nm}$ 

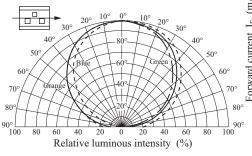


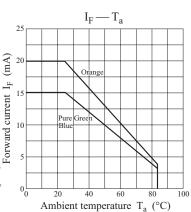








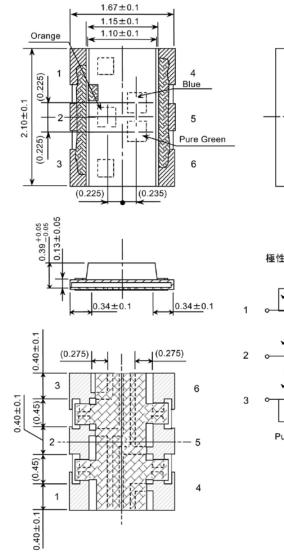




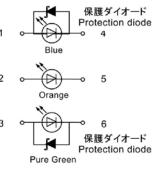
# **Panasonic**

Package (Unit: mm)

# KLTFTN6K2740



極性/Polarity



• Pin name

1, 2, 3: Anode

4, 5, 6: Cathode

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